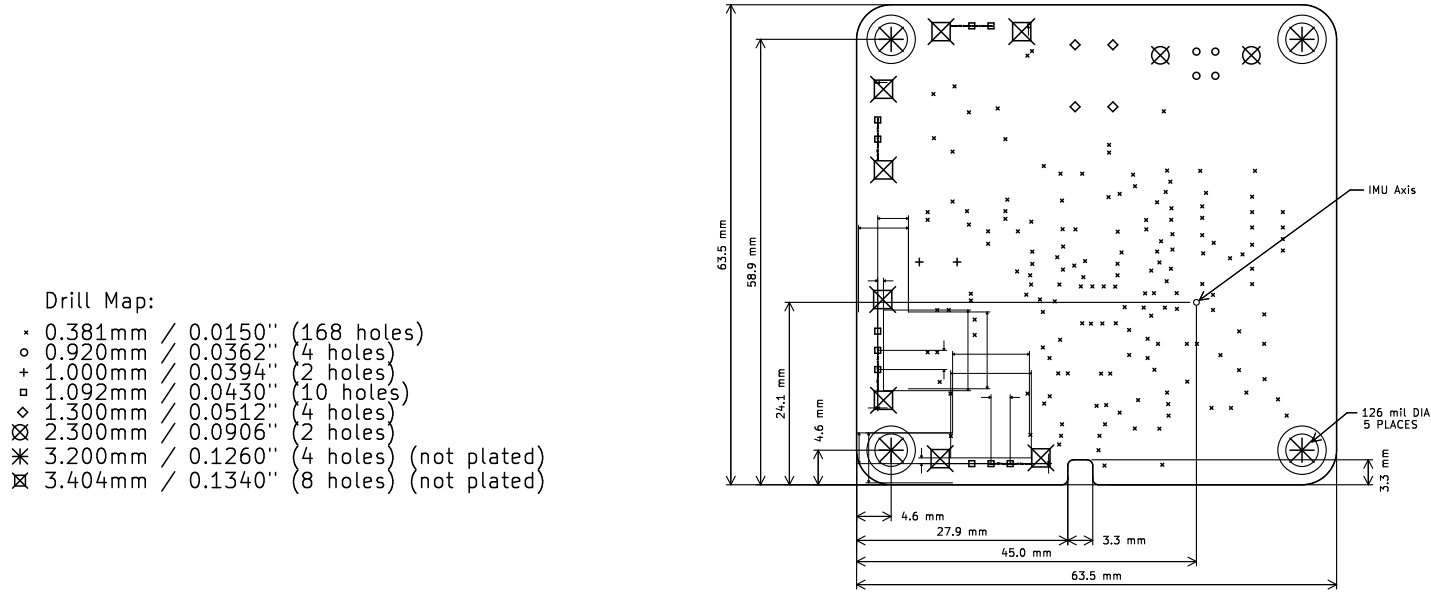


Layer Name	Type	Material	Thickness (mils)	Color	Epsilon R	Loss Tangent
F.Silkscreen	Top Silk Screen	Not specified	0 mils	Not specified	1	0
F.Paste	Top Solder Paste		0 mils		1	0
F.Mask	Top Solder Mask	Not specified	0.3937007874 mils	Not specified	3.3	0
F.Cu	copper		1.377952756 mils		1	0
Dielectric	prepreg	FR4	3.93 mils	Not specified	4.5	0.02
In1.Cu	copper		1.377952756 mils		1	0
Dielectric	core	FR4	48.81889764 mils	Not specified	4.5	0.02
In2.Cu	copper		1.377952756 mils		1	0
Dielectric	prepreg	FR4	3.937007874 mils	Not specified	4.5	0.02
B.Cu	copper		1.377952756 mils		1	0
B.Mask	Bottom Solder Mask	Not specified	0.3937007874 mils	Not specified	3.3	0
B.Paste	Bottom Solder Paste		0 mils		1	0
B.Silkscreen	Bottom Silk Screen	Not specified	0 mils	Not specified	1	0



BOARD CHARACTERISTICS

Copper Layer Count:	4	Board Thickness:	62.99 mils
Board overall dimensions:	2500.00 mils x 2500.00 mils		
Min track/spacing:	10.00 mils / 7.80 mils	Min hole diameter:	11.81 mils
Copper Finish:	None	Impedance Control:	No
Castellated pads:	No	Plated Board Edge:	No
Edge card connectors:	No		

FRC971 SPARTAN ROBOTICS

Sheet:
File: IMU-2X.kicad_pcb

Title: IMU-2X

Size: A Date: 2023-11-19
KiCad E.D.A. kicad-cli 7.0.9-7.0.9-ubuntu22.04.1

Rev: 2
Id: 1/1